SN54LS06, SN74LS06, SN74LS16 HEX INVERTER BUFFERS/DRIVERS WITH OPEN-COLLECTOR HIGH-VOLTAGE OUTPUTS

SDLS020D - MAY 1990 - REVISED FEBRUARY 2003

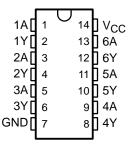
- Convert TTL Voltage Levels to MOS Levels
- High Sink-Current Capability
- Input Clamping Diodes Simplify System Design
- Open-Collector Driver for Indicator Lamps and Relays
- Inputs Fully Compatible With Most TTL Circuits

description/ordering information

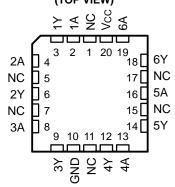
These hex inverter buffers/drivers feature high-voltage open-collector outputs to interface with high-level circuits (such as MOS), or for driving high-current loads, and also are characterized for use as inverter buffers for driving TTL inputs. The 'LS06 devices have a rated output voltage of 30 V, and the SN74LS16 has a rated output voltage of 15 V. The maximum sink current for the SN54LS06 is 30 mA, and for the SN74LS06 and SN74LS16 it is 40 mA.

These devices are compatible with most TTL families. Inputs are diode-clamped to minimize transmission effects, which simplifies design. Typical power dissipation is 175 mW, and average propagation delay time is 8 ns.

SN54LS06 . . . J PACKAGE SN74LS06, SN74LS16 . . . D, DB, N, OR NS PACKAGE (TOP VIEW)







NC - No internal connection

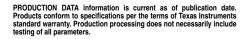
ORDERING INFORMATION

TA	PACI	KAGE†	ORDERABLE PART NUMBER	TOP-SIDE MARKING		
0°C to 70°C	PDIP – N	Tube	SN74LS06N	SN74LS06N		
	SOIC - D	Tube	SN74LS06D	LS06		
	30IC = D	Tape and reel	SN74LS06DR	L306		
	SOP - NS	Tape and reel	SN74LS06NSR	74LS06		
	SSOP – DB	Tape and reel	SN74LS06DBR	LS06		
-55°C to 125°C	CDIP – J	Tube	SN54LS06J	SN54LS06J		
	ODII	Tube	SNJ54LS06J	SNJ54LS06J		
	LCCC - FK	Tube	SNJ54LS06FK	SNJ54LS06FK		

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



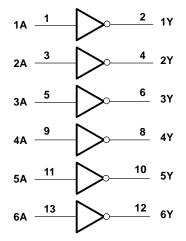
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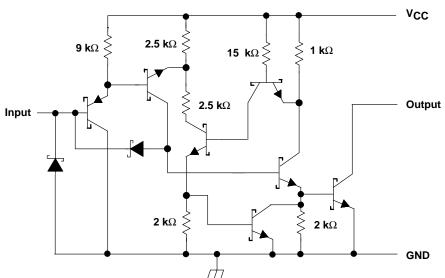
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logic diagram (positive logic)



Pin numbers shown are for the D, DB, J, N, and NS packages.

schematic (each gate)



Resistor values shown are nominal.

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V _{CC}		7	٧
Input voltage, V _I (see Note 1)		5.5	V
Output voltage, VO (see Notes 1 and 2): SN54L			
SN74L	LS16	15	V
Package thermal impedance, θ_{JA} (see Note 3): I	D package	86°C/	W
[DB package	96°C/	W
1	N package	80°C/	W
1	NS package	76°C/	W
Storage temperature range, Teta	. •		

NOTES: 1. All voltage values are with respect to GND.

- 2. This is the maximum voltage that should be applied to any output when it is in the off state.
- 3. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 4)

			SN54LS06			SN74LS06 SN74LS16			UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	
Vcc	Supply voltage		4.5	5	5.5	4.75	5	5.25	V
V_{IH}	High-level input voltage		2			2			V
V _{IL}	Low-level input voltage				8.0			8.0	V
V	V High level systems where	'LS06			30			30	V
V _{OH} High-le	High-level output voltage	SN74LS16						15] '
l _{OL}	Low-level output current				30			40	mA
TA	Operating free-air temperature		-55		125	0		70	°C

NOTE 4: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS [‡]		SN54LS06			SN74LS06 SN74LS16			UNIT	
				MIN	TYP§	MAX	MIN	TYP§	MAX	
VIK	$V_{CC} = MIN,$	I _I = -12 mA				-1.5			-1.5	V
lou	Voc - MIN	V _{IL} = 0.8 V	'LS06, V _{OH} = 30 V			0.25			0.25	mA
ЮН	ACC = IVIIIA'		SN74LS16, V _{OH} = 15 V						0.25	
	V _{CC} = MIN,	V _{IH} = 2 V	I _{OL} = 16 mA		0.25	0.4		0.25	0.4	V
VOL			$I_{OL} = 30 \text{ mA}$			0.7				
			I _{OL} = 40 mA						0.7	
II	$V_{CC} = MAX$,	V _I = 7 V				1			1	mA
lіН	$V_{CC} = MAX$,	V _I = 2.4 V				20			20	μΑ
Ι _{ΙL}	$V_{CC} = MAX$,	V _I = 0.4 V				-0.2			-0.2	mA
ІССН	$V_{CC} = MAX$					18			18	mA
ICCL	V _{CC} = MAX					60			60	mA

For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

[§] All typical values are at $V_{CC} = 5$ V, and $T_A = 25$ °C.



[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

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The SN74LS16 is obsolete and is no longer supplied.

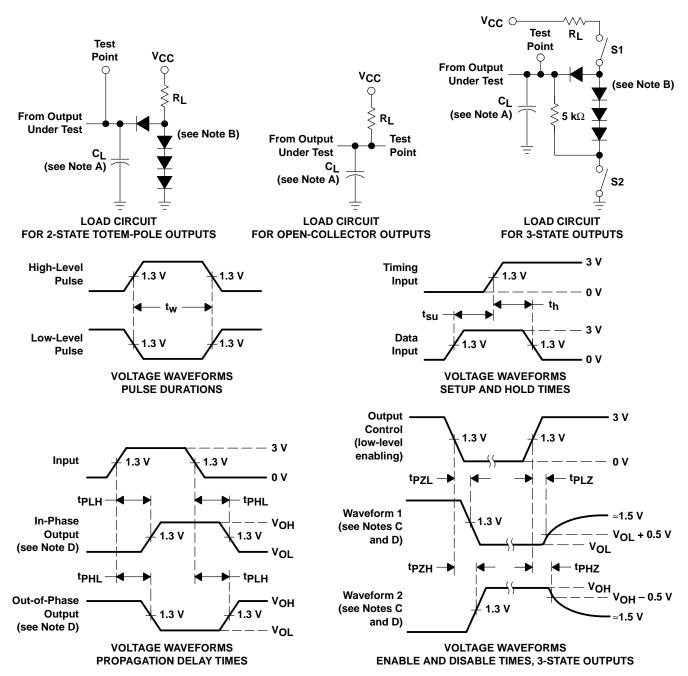
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switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$ (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	MAX	UNIT
t _{PLH}	Α	Y	B: - 110 0 C: - 15 pE	7	15	20
^t PHL			$R_L = 110 \Omega$, $C_L = 15 pF$	10	20	ns

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PARAMETER MEASUREMENT INFORMATION

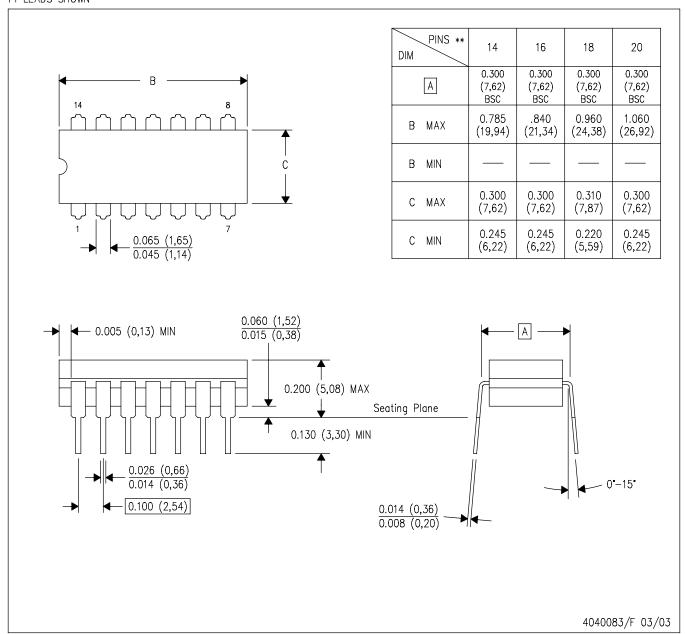


- NOTES: A. C_L includes probe and jig capacitance.
 - B. All diodes are 1N3064 or equivalent.
 - C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - D. S1 and S2 are closed for tpLH, tpHZ, and tpLZ; S1 is open and S2 is closed for tpZH; S1 is closed and S2 is open for tpZL.
 - E. Phase relationships between inputs and outputs have been chosen arbitrarily for these examples.
 - F. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_O \approx 50~\Omega$, $t_\Gamma \leq$ 1.5 ns, $t_f \leq$ 2.6 ns.
 - G. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms



14 LEADS SHOWN



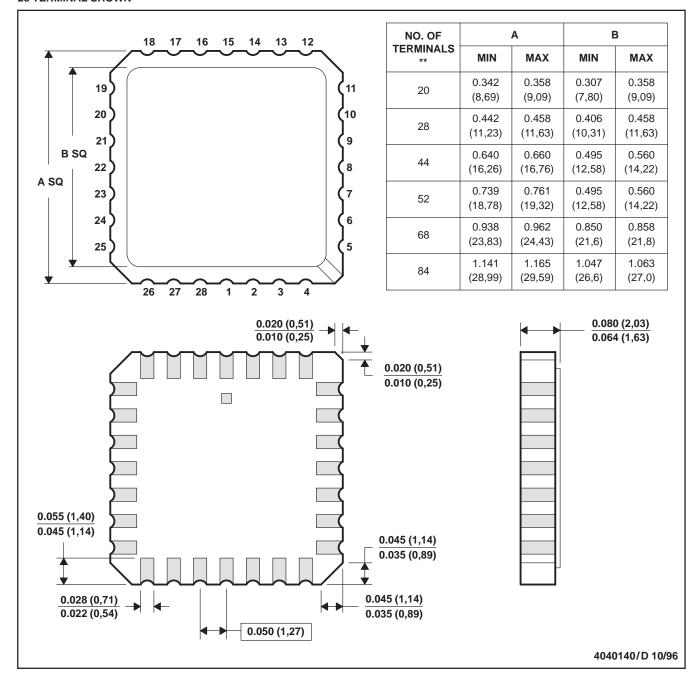
NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

FK (S-CQCC-N**)

28 TERMINAL SHOWN

LEADLESS CERAMIC CHIP CARRIER



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004

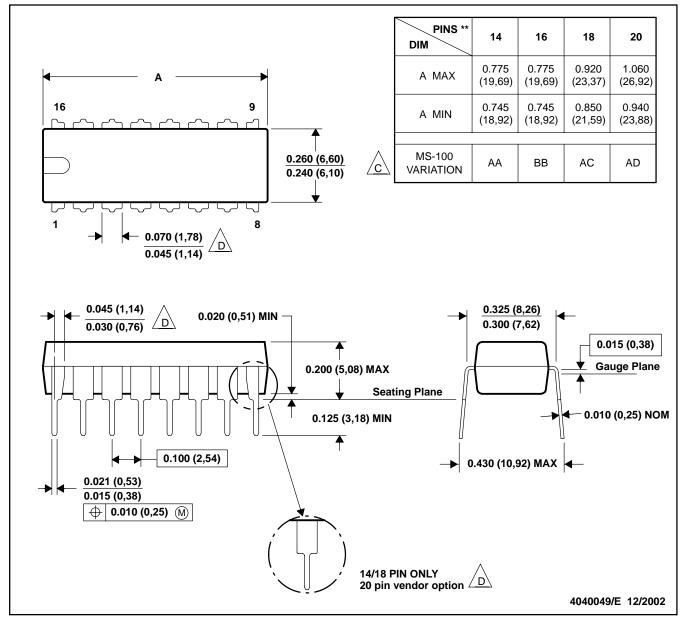


1

N (R-PDIP-T**)

16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

Falls within JEDEC MS-001, except 18 and 20 pin minimum body Irngth (Dim A).

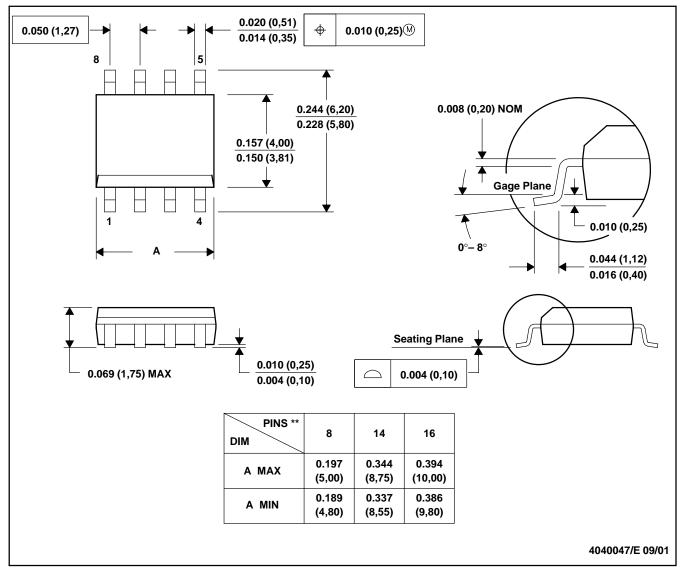
The 20 pin end lead shoulder width is a vendor option, either half or full width.



D (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

8 PINS SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).

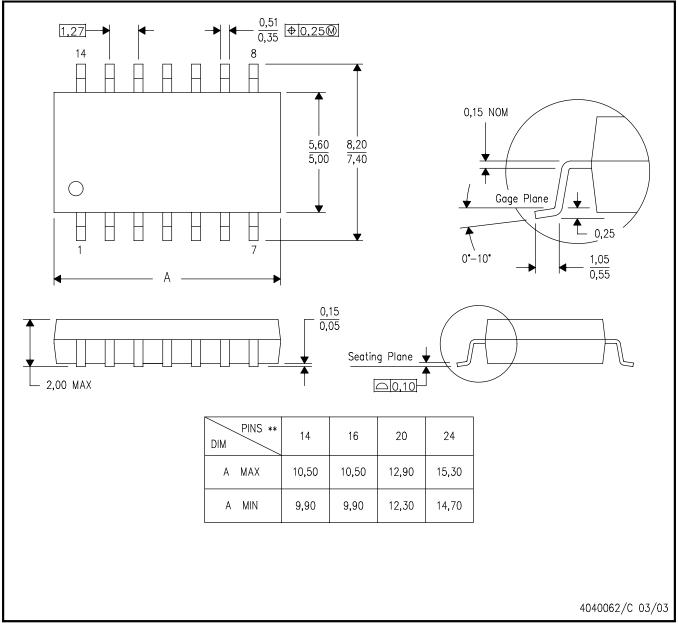
D. Falls within JEDEC MS-012

MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-150

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